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Small switching (30V, 0.1A)

UM5K1N

●Features

- 1) Two 2SK3018 transistors in a single UMT package.
- 2) Mounting cost and area can be cut in half.
- 3) Low on-resistance.
- 4) Low voltage drive (2.5V) makes this device ideal for portable equipment.
- 5) Easily designed drive circuits.

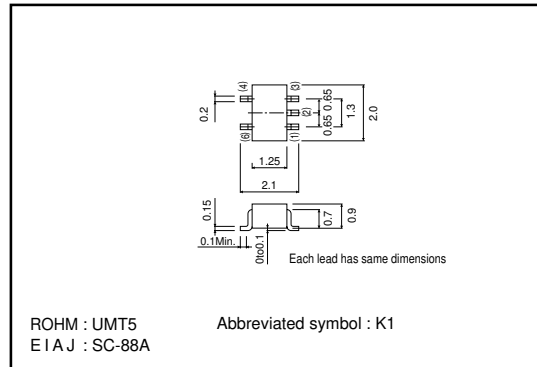
●Applications

Interfacing, switching (30V, 100mA)

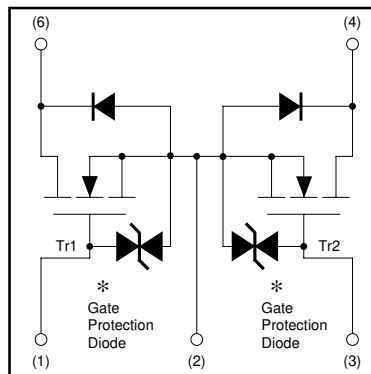
●Structure

Silicon N-channel
MOSFET

●External dimensions (Units : mm)



●Equivalent circuit



- (1) Tr1 Gate
- (2) Source
- (3) Tr2 Gate
- (4) Tr2 Drain
- (6) Tr1 Drain

* A protection diode has been built in between the gate and the source to protect against static electricity when the product is in use. Use the protection circuit when rated voltages are exceeded.

●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
UM5K1N		○

Transistors

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-source voltage	V _{DSS}	30	V
Gate-source voltage	V _{GSS}	±20	V
Drain current	Continuous	I _D	100 mA
	Pulsed	I _{DP} *1	200 mA
Reverse drain current	Continuous	I _{DR}	100 mA
	Pulsed	I _{DRP} *1	200 mA
Total power dissipation (Tc=25°C)	P _D *2	150	mW
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55~+150	°C

*1 Pw≤10μs, Duty cycle≤50%

*2 With each pin mounted on the recommended lands.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Gate-source leakage	I _{GSS}	-	-	±1	μA	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	I _D =10μA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	-	-	1.0	μA	V _{DS} =30V, V _{GS} =0V
Gate threshold voltage	V _{GS(th)}	0.8	-	1.5	V	V _{DS} =3V, I _D =100μA
Static drain-source on-stage resistance	R _{DS(on)}	-	5	8	Ω	I _D =10mA, V _{GS} =4V
	R _{DS(on)}	-	7	13	Ω	I _D =1mA, V _{GS} =2.5V
Forward transfer admittance	Y _{fs}	20	-	-	mS	I _D =10mA, V _{DS} =3V
Input capacitance	C _{iss}	-	13	-	pF	V _{DS} =5V
Output capacitance	C _{oss}	-	9	-	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	-	4	-	pF	f=1MHz
Turn-on delay time	t _{d(on)}	-	15	-	ns	I _D =10mA, V _{DD} =5V
Rise time	t _r	-	35	-	ns	V _{GS} =5V
Turn-off delay time	t _{d(off)}	-	80	-	ns	R _L =500Ω
Fall time	t _f	-	80	-	ns	R _{GS} =10Ω

●Electrical characteristic curves

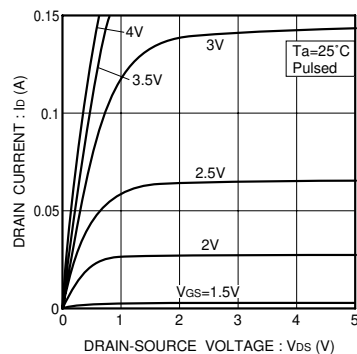


Fig.1 Typical output characteristics

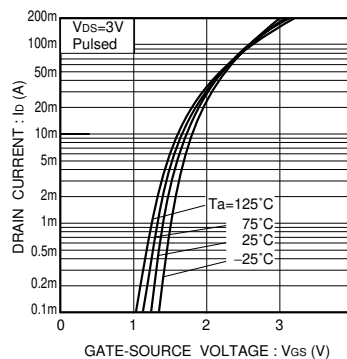


Fig.2 Typical transfer characteristics

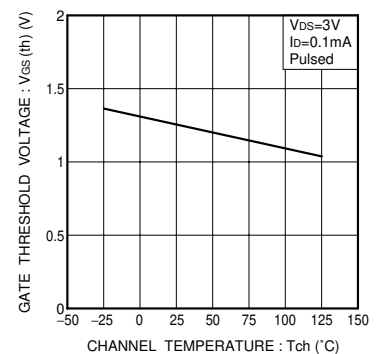


Fig.3 Gate threshold voltage vs. channel temperature

Transistors

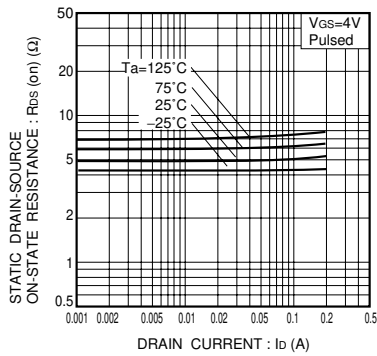


Fig.4 Static drain-source on-state resistance vs. drain current (I)

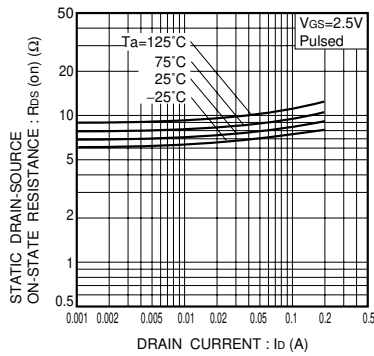


Fig.5 Static drain-source on-state resistance vs. drain current (II)

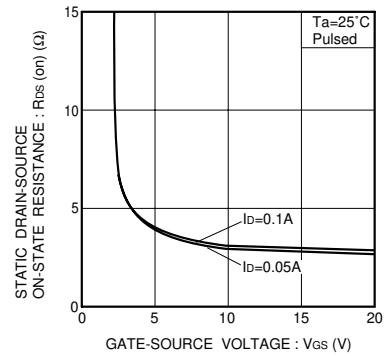


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

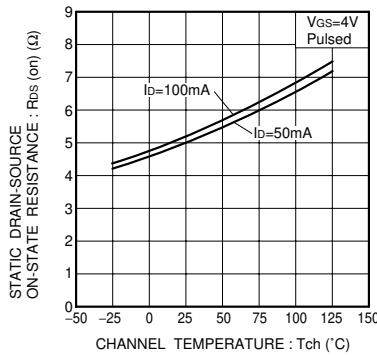


Fig.7 Static drain-source on-state resistance vs. channel temperature

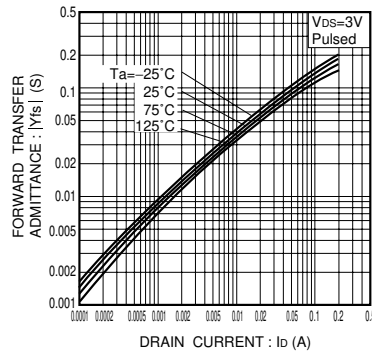


Fig.8 Forward transfer admittance vs. drain current

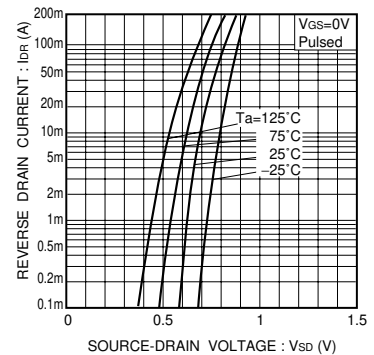


Fig.9 Reverse drain current vs. source-drain voltage (I)

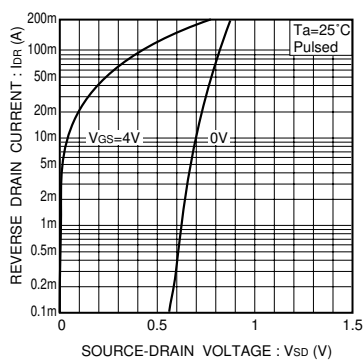


Fig.10 Reverse drain current vs. source-drain voltage (II)

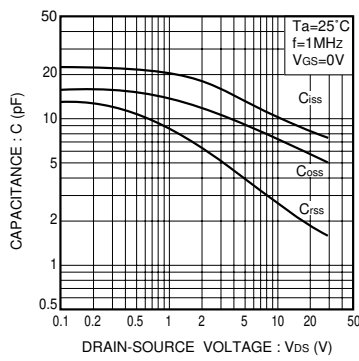


Fig.11 Typical capacitance vs. drain-source voltage

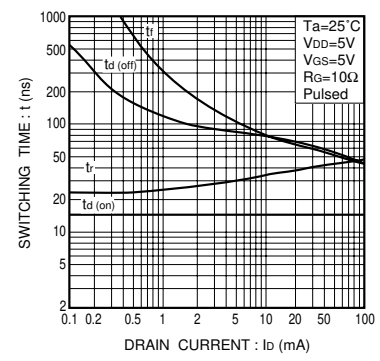


Fig.12 Switching characteristics (See Figures 13 and 14 for the measurement circuit and resultant waveforms)

Transistors

● Switching characteristics measurement circuit

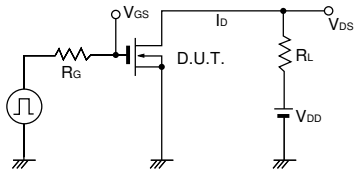


Fig.13 Switching time measurement circuit

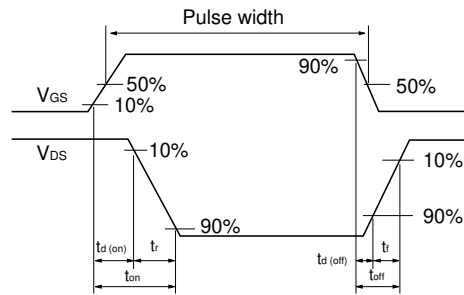


Fig.14 Switching time waveforms

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